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N-channel TrenchMOS logic level FET Rev. 02 — 28 April 2011

Product data sheet

Product profile 1.

1.1 General description

Logic level N-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product has been designed and qualified to the appropriate AEC standard for use in automotive critical applications.

1.2 Features and benefits

Low conduction losses due to low on-state resistance

1.3 Applications

Automotive and general purpose power switching

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	-	55	V
I _D	drain current	T _{mb} = 25 °C	-	-	34	А
P _{tot}	total power dissipation		-	-	85	W
Static cha	aracteristics					
R _{DSon}	DSon drain-source on-state	V_{GS} = 10 V; I _D = 25 A; T _j = 25 °C	-	24	32	mΩ
resistance	resistance	$V_{GS} = 5 \text{ V}; \text{ I}_{D} = 25 \text{ A}; \text{ T}_{j} = 25 \text{ °C}$	-	26	35	mΩ
Avalanch	e ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$ \begin{split} I_D &= 14 \text{ A}; \text{V}_{\text{sup}} \leq 25 \text{ V}; \\ R_{\text{GS}} &= 50 \Omega; \text{V}_{\text{GS}} = 5 \text{ V}; \\ T_{j(\text{init})} &= 25 ^{\circ}\text{C}; \text{ unclamped} \end{split} $	-	-	49	mJ



N-channel TrenchMOS logic level FET

2. Pinning information

Table 2.	Pinning	information					
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	G	gate		-			
2	D	drain	mb				
3	S	source					
mb	D	mounting base; connected to drain		mbb076 S			

SOT78A (TO-220AB)

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BUK9535-55A	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78A

4. Limiting values

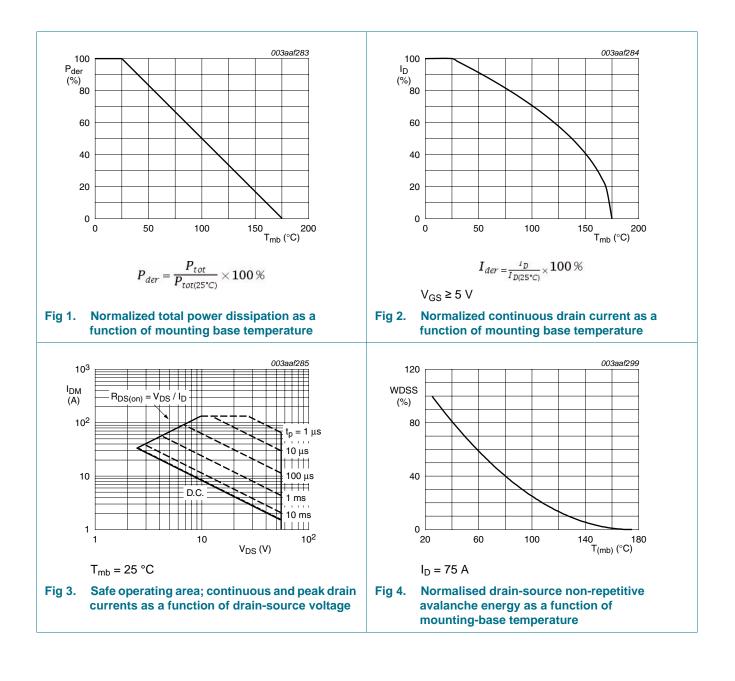
Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	55	V
V _{DGR}	drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$	-	55	V
V _{GS}	gate-source voltage		-10	10	V
I _D drain current	T _{mb} = 100 °C	-	24	А	
		T _{mb} = 25 °C	-	34	А
I _{DM}	peak drain current	T _{mb} = 25 °C; pulsed	-	133	А
P _{tot}	total power dissipation	T _{mb} = 25 °C	-	85	W
T _{stg}	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
V _{GSM}	peak gate-source voltage	pulsed; t _p ≤ 50 µs	-15	15	V
Source-drai	n diode				
Is	source current	T _{mb} = 25 °C	-	34	А
I _{SM}	peak source current	pulsed; T _{mb} = 25 °C	-	133	А
Avalanche r	uggedness				
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$\label{eq:ID} \begin{array}{l} I_{D} = 14 \; A; \; V_{sup} \leq 25 \; V; \; R_{GS} = 50 \; \Omega; \\ V_{GS} = 5 \; V; \; T_{j(init)} = 25 \; ^{\circ}C; \; unclamped \end{array}$	-	49	mJ
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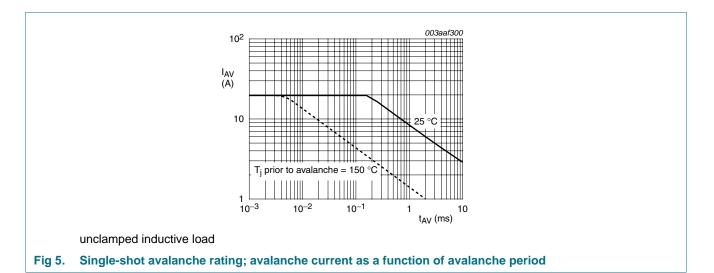
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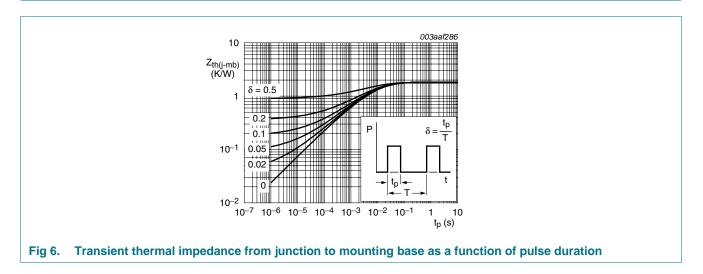
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5. Thermal characteristics

Table 5.Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base		-	-	1.8	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W



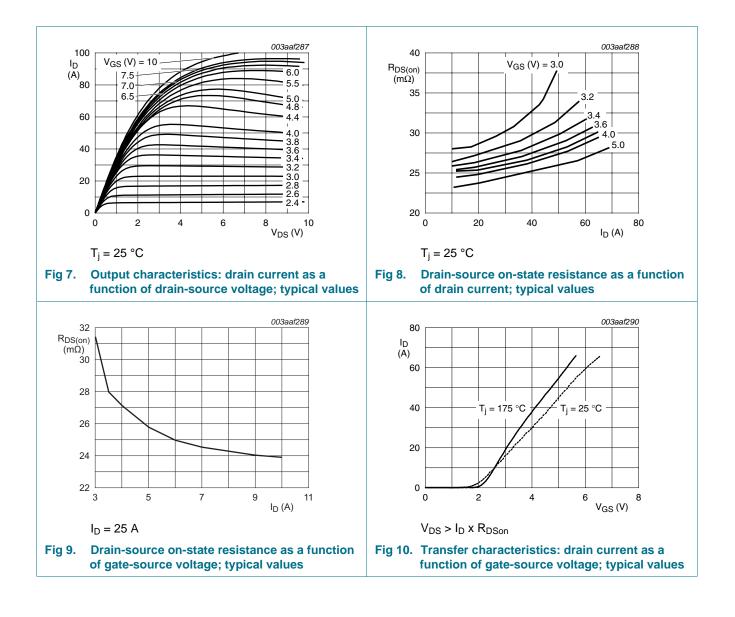
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6. Characteristics

Table 6.	Characteristics			_		
Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static cha	aracteristics					
V _{(BR)DSS}	drain-source breakdown	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ mV}; T_j = 25 \text{ °C}$	55	-	-	V
	voltage	$I_D = 0.25 \text{ mA}; V_{GS} = 0 \text{ mV}; T_j = -55 \text{ °C}$	50	-	-	V
V _{GS(th)}	gate-source threshold	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C}$	-	-	2.3	V
	voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}$	1	1.5	2	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C}$	0.5	-	-	V
I _{DSS}	drain leakage current	V_{DS} = 55 V; V_{GS} = 0 V; T_j = 25 °C	-	0.05	10	μA
		$V_{DS} = 55 \text{ V}; V_{GS} = 0 \text{ V}; \text{ T}_{j} = 175 \text{ °C}$	-	-	500	μΑ
I _{GSS}	gate leakage current	V_{GS} = 10 V; V_{DS} = 0 V; T_j = 25 °C	-	2	100	nA
		V_{GS} = -10 V; V_{DS} = 0 V; T_j = 25 °C	-	2	100	nA
R _{DSon}	drain-source on-state	V_{GS} = 4.5 V; I _D = 25 A; T _j = 25 °C	-	26.5	38	mΩ
res	resistance	V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C	-	24	32	mΩ
		V _{GS} = 5 V; I _D = 25 A; T _j = 175 °C	-	-	70	mΩ
		V _{GS} = 5 V; I _D = 25 A; T _j = 25 °C	-	26	35	mΩ
Dynamic	characteristics					
C _{iss}	input capacitance	V _{GS} = 0 V; V _{DS} = 25 V; f = 1 MHz; T _j = 25 °C	-	880	1173	pF
C _{oss}	output capacitance		-	165	198	pF
C _{rss}	reverse transfer capacitance		-	111	152	pF
t _{d(on)}	turn-on delay time	V_{DS} = 30 V; R _L = 1.2 Ω; V _{GS} = 5 V;	-	6	9	ns
t _r	rise time	R _{G(ext)} = 10 Ω; T _j = 25 °C	-	36	55	ns
t _{d(off)}	turn-off delay time		-	96	134	ns
t _f	fall time		-	73	102	ns
L _D	internal drain inductance	measured from contact screw on tab to centre of die ; $T_j = 25 \text{ °C}$	-	3.5	-	nH
		from drain lead 6 mm from package to centre of die ; $T_j = 25 \text{ °C}$	-	4.5	-	nH
L _S	internal source inductance	from source lead to source bond pad ; $T_j = 25 \text{ °C}$	-	7.5	-	nH
Source-d	rain diode					
V _{SD}	source-drain voltage	I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C	-	0.85	1.2	V
		I _S = 34 A; V _{GS} = 0 V; T _j = 25 °C	-	1.1	-	V
t _{rr}	reverse recovery time	I _S = 34 A; dI _S /dt = -100 A/μs; V _{GS} = -10 V;	-	36	-	ns
Q _r	recovered charge	V _{DS} = 30 V; T _j = 25 °C	-	0.07	-	μC

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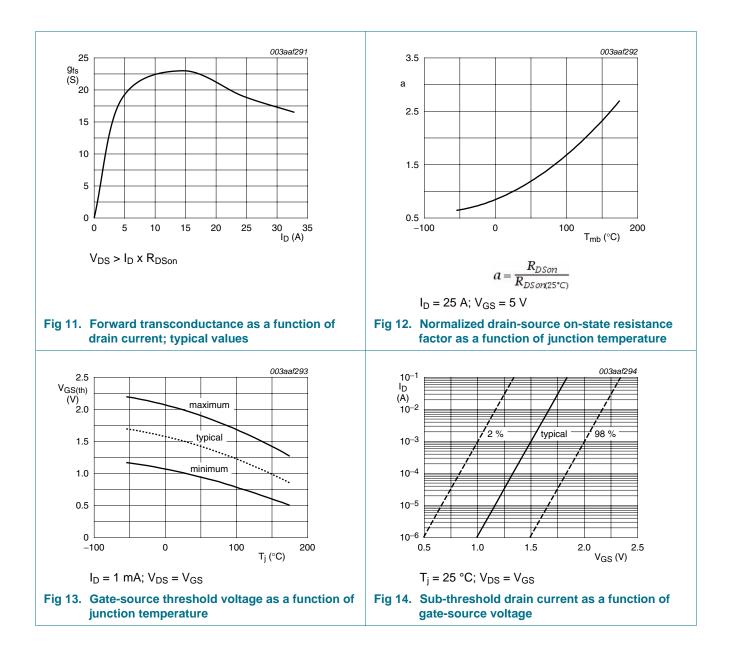
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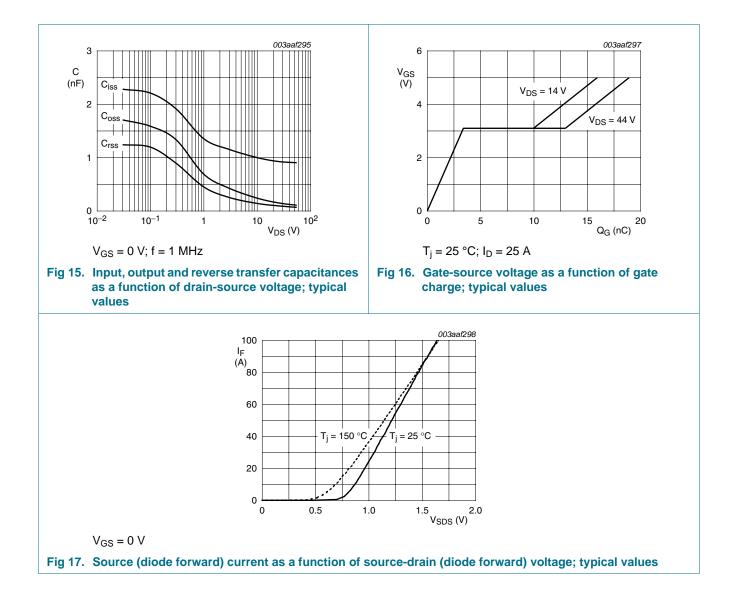
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BUK9535-55A Product data sheet

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7. Package outline

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	IONS (m							sca			. (1)	La				1
UNIT	Α	A ₁	b	b ₁	с	D	ц. D1	E	ale e	L	L ₁ ⁽¹⁾	L ₂ max.	p	q	Q 26	
								sca		<u> </u>	L1 ⁽¹⁾ 3.30 2.79	L2 max. 3.0	p 3.8 3.6	q 3.0 2.7	Q 2.6 2.2]
UNIT mm ote	A 4.5 4.1	A 1 1.39 1.27	b 0.9 0.6	b1 1.3 1.0	c 0.7	D 15.8	Lu D ₁ 6.4	E 10.3	ale e	L 15.0	3.30	max.	3.8	3.0	2.6	
UNIT mm ote . Termi	A 4.5 4.1 nals in th	A 1 1.39 1.27	b 0.9 0.6	b1 1.3 1.0	c 0.7	D 15.8 15.2	Lu D ₁ 6.4	sca E 10.3 9.7	ale e	L 15.0	3.30	max.	3.8 3.6	3.0 2.7	2.6 2.2	
UNIT mm lote . Termi	A 4.5 4.1	A 1 1.39 1.27	b 0.9 0.6	b1 1.3 1.0	c 0.7 0.4	D 15.8 15.2	L D ₁ 6.4 5.9	E 10.3 9.7	ale e	L 15.0	3.30	max.	3.8 3.6 EUR	3.0	2.6 2.2	

Fig 18. Package outline SOT78A (TO-220AB)

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N-channel TrenchMOS logic level FET

8. Revision history

Table 7. Revision hi	story						
Document ID	Release date	Data sheet status	Change notic	e Supersedes			
BUK9535-55A v.2	20110428	Product data sheet	-	BUK9535_9635-55A v.1			
Modifications:		 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 					
	 Legal texts 	have been adapted to the	e new company na	ame where appropriate.			
	 Type number 	per BUK9535-55A separat	ed from data shee	et BUK9535_9635-55A v.1.			
BUK9535_9635-55A v.1	20000201	Product specification	-	-			

N-channel TrenchMOS logic level FET

9. Legal information

9.1 Data sheet status

Document status [1] [2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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BUK9535-55A

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11. Contents

1	Product profile1
1.1	General description1
1.2	Features and benefits1
1.3	Applications1
1.4	Quick reference data1
2	Pinning information2
3	Ordering information2
4	Limiting values2
5	Thermal characteristics4
6	Characteristics5
7	Package outline9
8	Revision history10
9	Legal information11
9.1	Data sheet status11
9.2	Definitions11
9.3	Disclaimers
9.4	Trademarks12
10	Contact information12

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